SILICON TRANSISTOR

AUDIO FREQUENCY AMPLIFIER, SWITCHING NPN SILICON EPITAXIAL TRANSISTORS

FEATURES

NEC

 Low VCE(sat) VCE(sat) = 0.15 V Max (@Ic/IB = 0.5 A/25 High DC Current Gain hFE = 150 to 600 (@VCE = 2.0 V, IC = 0 	,	
ABSOLUTE MAXIMUM RATINGS		
Maximum Voltage and Current (T _A = 25	°C)	
Collector to Base Voltage	Vсв0	30 V
Collector to Emitter Voltage	Vce0	30 V
Emitter to Base Voltage	Veb0	6.0 V
Collector Current (DC)	IC(DC)	5.0 A
Collector Current (Pulse)*	C(Pulse) 8.0 A
Base Current (DC)	Ів	1.0 A
* PW \leq 10ms, Duty Cycle \leq 10 %		
Maximum Power Dissipation		
Total Power Dissipation (Tc = 25 °C)	Pτ	10 W
Total Power Dissipation (T _A = 25 °C)	Pτ	1.0 W
Maximum Temperature		
Junction Temperature	Tj	150 °C
Storage Temperature	Tstg	–55 to 150 °C

PACKAGE DIMENSIONS in millimeters (inches) 8.5 MAX. 2.8 MAX. (0.334 MAX.) (0.110 MAX.) 3.8 ± 0.2 (0.149) ϕ 3.2 ± 0.2 (ϕ 0.126) MAX. 20 12.0 MAX. ò (0.472 N 2 3 1 1.2 13.0 MIN. (0.512 MIN.) +0 068) (0.047)0.55+0.08 (0.021) 0.8+0.08 (0.031) 1.2 2.3 2.3 (0.047)(0.090) (0.090) 1. Emitter 2. Collector connected to mounting plane 3. Base

ELECTRICAL CHARACTERISTISC (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Collector Cutoff Currnet	Ісво	$V_{CB} = 30 \text{ V}, \text{ Ie} = 0$			100	nA
Emitter Cutoff Current	Іево	$V_{EB} = 6.0 V, I_{C} = 0$			100	nA
DC Current Gain	hfe1	Vce = 2.0 V, Ic = 0.5 A	150		600	_
DC Current Gain	hfe2	Vce = 2.0 V, Ic = 3.0 A	70			_
Collector Saturation Voltage	VCE(sat)1	Ic = 0.5 A, Iв = 25 mA		0.05	0.15	V
Collector Saturation Voltage	VCE(sat)2	Ic = 1.0 A, Iв = 50 mA		0.09	0.25	V
Collector Saturation Voltage	VCE(sat)3	Ic = 2.0 A, I _B = 100 mA		0.16	0.40	V
Collector Saturation Voltage	VCE(sat)4	Ic = 3.0 A, I _B = 75 mA		0.27	1.0	V
Base Saturation Voltage	VBE(sat)	Ic = 1.0 A, Iв = 50 mA		0.83	1.50	V
Gain Bandwidth Product	f⊤	$V_{CE} = 10 \text{ V}, \text{ Ie} = 50 \text{ mA}$		100		MHz
Output Capacitance	Cob	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		46		pF

The information in this document is subject to change without notice.



DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA





Tc -Case Temperature - °C

100 AN 10.7 ms Ic - Collector Current - A C(pulse) 10 Romer Dission Linited T.Ms TOMS IC(DC) 1 Splimited Tc = 25 °C Single Pulse 0.1 0.1 10 1 100 VCE - Collector to Emitter Voltage - V

FORWARD BIAS SAFE OPERATING AREA



Collector to Emitter Voltage vs Collector Current





Ic - Collector Current - A



COLLECTOR SATURATION VOLTAGE vs COLLECTOR CURRENT

BASE SATURATION VOLTAGE vs COLLECTOR CURRENT



Ic - Collector Current - A



OUTPUT CAPACITANCE vs COLLECTOR TO BASE VOLTAGE



REFERENCE

Document Name	Document No.		
NEC semiconductor device reliability/quality control system	TEI-1202		
Quality grade on NEC semiconductor devices	IEI-1209		
Semiconductor device mounting technology manual	C10535E		
Semiconductor device package manual	C10943X		
Guide to quality assurance for semiconductor devices	MEI-1202		
Semiconductor selection guide	X10679E		

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.

NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.

While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customers must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.

NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

- Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots
- Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
- Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices is "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact an NEC sales representative in advance.

Anti-radioactive design is not implemented in this product.